

### FEATURES

- 8, 10 and 12-Bit resolutions
- Settling times to 25ns
- $\pm 20\text{ppm}/^\circ\text{C}$  max. gain tempco
- Unipolar or bipolar operation
- Current output
- Internal feedback resistors
- High-reliability MIL-STD-883 models



### PRODUCT OVERVIEW

The DAC-HF Series of hybrid DAC's are ultra high-speed, current output devices. They incorporate state-of-the-art performance in a miniature package, achieving maximum output settling times of 25ns for the 8 and 10-bit models and 50ns for the 12-bit model. They can be used to drive a resistor load directly for up to  $\pm 1\text{V}$  output or a fast operational amplifier (such as DATEL's AM-500) for higher voltage outputs with sub-microsecond settling times. A tapped feedback resistor and a bipolar offset resistor are included internally to give five programmable output voltage ranges with an external operational amplifier.

The DAC-HF design combines proven hybrid construction techniques with advanced circuit design to realize high-speed current switching. The design incorporates fast PNP current switches driving a low-impedance R-2R thin-film ladder network. The nichrome thin-film resistor network is deposited by electron beam evaporation on a lowcapacitance substrate to assure high-speed performance. The resistors are then functionally trimmed by laser for optimum linearity.

INPUT/OUTPUT CONNECTIONS			
PIN	FUNCTION	PIN	FUNCTION
1	BIT 1 (MSB)	24	+15V SUPPLY
2	BIT 2	23	GROUND
3	BIT 3	22	-15V SUPPLY
4	BIT 4	21	REFERENCE OUT
5	BIT 5	20	BIPOLAR OFFSET
6	BIT 6	19	10V RANGE
7	BIT 7	18	OUTPUT
8	BIT 8	17	20V RANGE
9	BIT 9 *	16	REFERENCE IN
10	BIT 10 *	15	GROUND
11	BIT 11 *	14	GROUND
12	BIT 12 (LSB) *	13	GROUND

\* See note in Figure 1

### BLOCK DIAGRAM

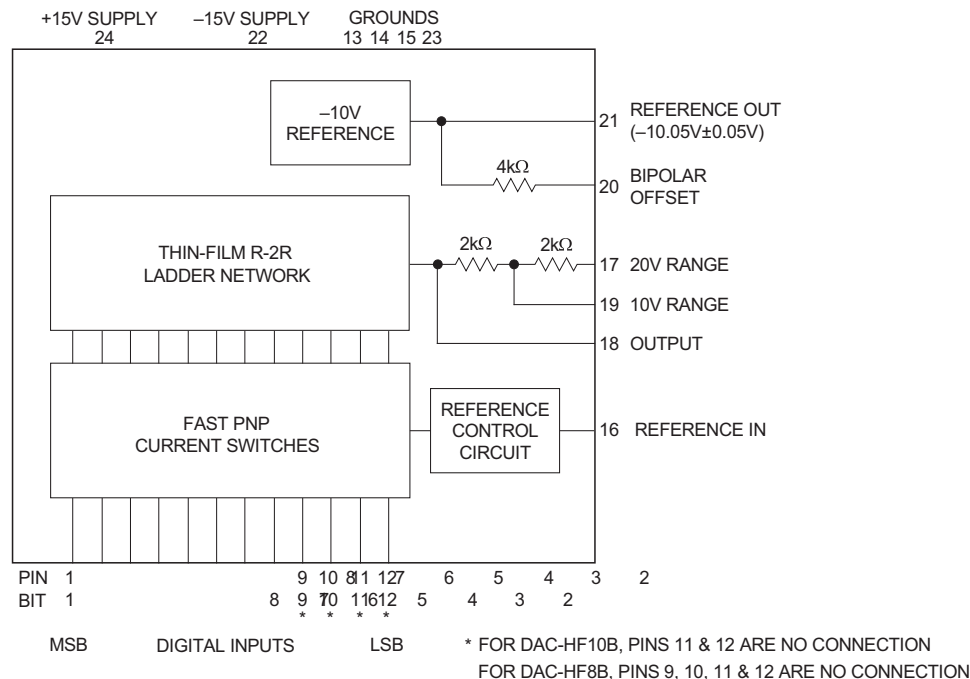


Figure 1. DAC-HF Functional Block Diagram

### FUNCTIONAL SPECIFICATIONS

(Typical at +25°C and ±15V supplies unless otherwise noted.)

DESCRIPTION	8B	10B	12B
INPUTS			
Resolution, Bits	8	10	12
Coding, Unipolar Output	Straight binary		
Coding, Bipolar Output	Offset binary		
Input Logic Level, Bit ON ("1")	+2.0V to +5.5V at +40μA		
Input Logic Level, Bit OFF ("0")	0V to +0.8V at −2.6mA		
PERFORMANCE			
Nonlinearity Error, max.	±0.012%		
T <sub>MIN</sub> to T <sub>MAX</sub>	±0.024%		
Differential Nonlinearity Error, max.	±0.012%		
T <sub>MIN</sub> to T <sub>MAX</sub>	±0.024%		
Monotonicity	Guaranteed over oper. temp. range		
Gain Tempco, max.	±20ppm/°C		
Offset Tempco, Bipolar, max.	±10ppm/°C of FSR ②		
Zero Tempco, max.	±1.5ppm/°C of FSR ②		
Settling Time, ns max. ③	25	25	50
Power Supply Sensitivity	±0.01%/Supply		
OUTPUTS			
Output Current Range, Unipolar	0 to +5mA		
Output Current Range, Bipolar	±2.5mA		
Output Compliance Voltage	±1.2V 0		
Output Voltage Ranges ①	to −5V 0		
	to −10V		
	±2.5V		
	±5V ±10V		
	400 Ohms		
Output Resistance	±10%		
Output Capacitance	15pF		
Output Leakage Current, All Bits OFF	15nA		
POWER REQUIREMENTS			
Supply Voltages	±15V ±0.5V		
Positive Quiescent Current, max.	40mA	45mA	50mA
Negative Quiescent Current, max.	17mA	17mA	17mA
PHYSICAL ENVIRONMENTAL			
Operating Temperature Range, Case	0°C to +70°C (BMC)		
	−55°C to +125°C (BMM, 883)		
Storage Temperature Range	−65°C to +150°C		
Package Type	24-pin ceramic DDIP		
Weight	0.22 ounces (6.3 grams)		

#### Footnotes:

- ① With external operational amplifier.
- ② FSR is Full Scale Range, or the difference between minimum and maximum output values.
- ③ Full-scale current change to ±1LSB with 400Ω load.

ABSOLUTE MAXIMUM RATINGS		
PARAMETERS	LIMITS	UNITS
Positive Supply, Pin 24	+18	Volts
Negative Supply, Pin 22	-18	Volts
Digital Input Voltage, Pins 1-12	+15	Volts
Lead Temperature (soldering, 10s)	300	Volts

### TECHNICAL NOTES

- Proper operation of the DAC-HF Series converters is dependent on good board layout and connection practices. Bypass supplies as shown in the connection diagrams. Mount bypass capacitors close to the converter, directly to the supply pins where possible.
- Use of a ground plane is particularly important in highspeed D/A converters as it reduces high-frequency noise and aids in decoupling the digital inputs from the analog output. Avoid ground loop problems by connecting all grounds on the board to the ground plane. The remainder of the ground plane should include as much of the circuit board as possible.
- When the converter is configured for voltage output with an external operational amplifier, keep the leads from the converter to the output amplifier as short as possible.
- The high-speed current switching technique used in the DAC-HF Series inherently reduces the amplitude and duration of large transient spikes at the output ("glitches"). The most severe glitches occur at half-scale, the major carry transition from 011 ... 1 to 100 ... 0 or vice versa. At this time, a skewing of the input codes can create a transition state code of 111 ... 1. The duration of the "transition state code" is dependent on the degree of skewing, but its effect is dependent on the speed of the DAC (an ultra-fast DAC will respond to these brief spurious inputs to a greater degree than a slow DAC). Minimize the effects of input skewing by using a highspeed input register to match input switching times. The input register recommended for use with the DAC-HF is easily implemented with two Texas Instruments SN74S174 hex D-type flip-flops. This register will reduce glitches to a very low level and ensure fast output settling times.
- Test the DAC-HF using a low-capacitance test probe (such as a 10X probe). Take care to assure the shortest possible connection between probe ground and circuit ground. Long probe ground leads may pick up environmental E.M.I. causing artifacts on the scope display, i.e., signals that do not originate at the unit under test.
- Passive components used with the DAC-HF may be as indicated here: 0.1μF and 1μF bypass capacitors should be ceramic type and tantalum type respectively; the 400Ω output load is a ±0.1%, 10ppm/°C, metal-film type; adjustment potentiometers are cermet types; other resistors may be ±10% carbon composition types.
- Output voltage compliance is ±1.2V to preserve the linearity of the converter. In the bipolar mode, the DAC-HF can be operated with no load to give an output voltage of ±1.0V. In the unipolar mode, the load resistance must be less than 600Ω to give less than +1.2V output. The specified output currents of 0 to +5mA and ±2.5mA are measured into a short circuit or an operational amplifier summing junction.

### CALIBRATION PROCEDURE

#### Unipolar Output Current

1. Connect the converter as shown in Figure 2.
2. Set all inputs low and adjust the ZERO ADJUST potentiometer for a reading of 0V at the output.
3. Set all inputs high and adjust the GAIN ADJUST potentiometer for a reading of  $-F.S. + 1LSB$  (See Table 1).

#### Bipolar Output Current

1. Connect the converter as shown in Figure 3.
2. Set all inputs low and adjust the OFFSET ADJUST and LOAD potentiometer for an output reading of  $+F.S.$  (See Table 2).
3. Set all inputs high and adjust the GAIN ADJUST potentiometer for an output reading of  $-F.S. + 1LSB$  (See Table 2).

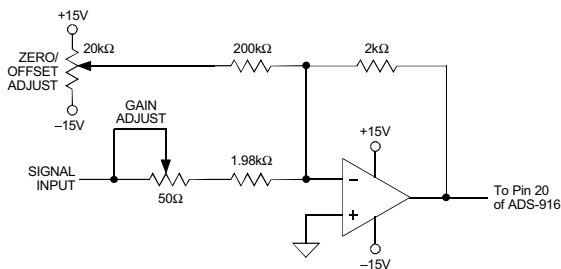


Figure 2. DAC-HF Calibration Circuit

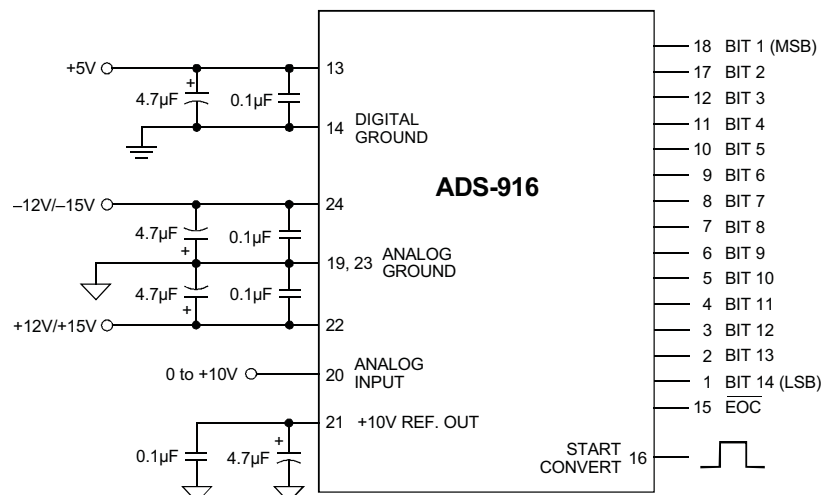


Figure 3. Typical DAC-HF Connection Diagram

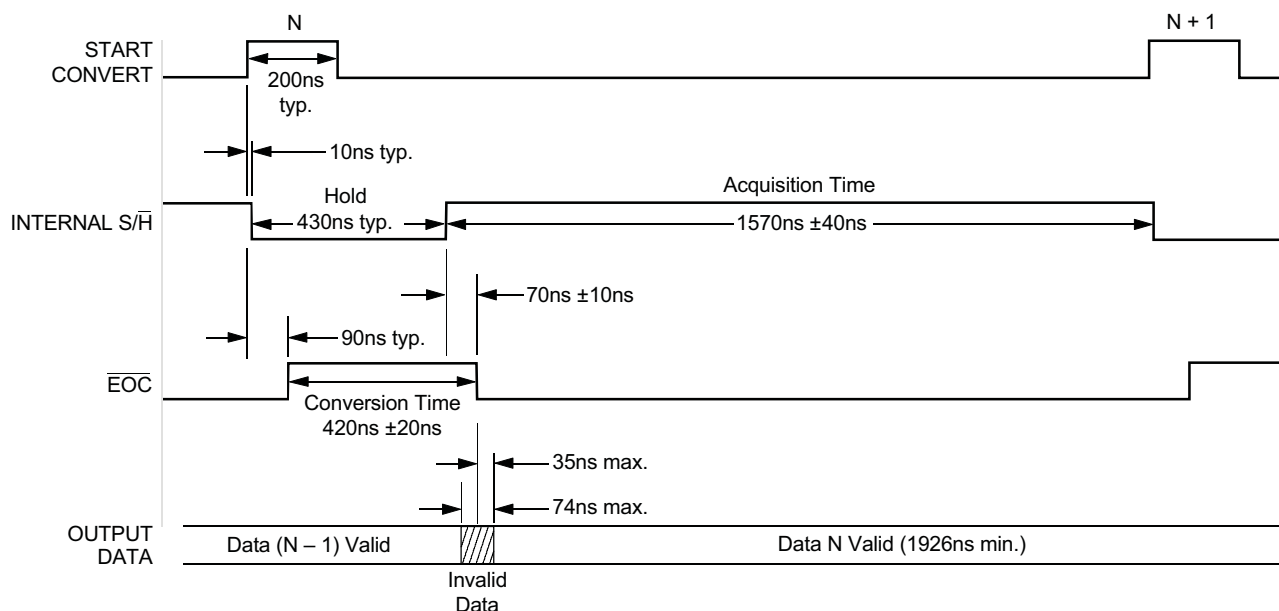
## THERMAL REQUIREMENTS

All DATEL sampling A/D converters are fully characterized and specified over operating temperature (case) ranges of 0 to +70°C and -55 to +125°C. All room-temperature ( $T_A = +25^\circ\text{C}$ ) production testing is performed without the use of heat sinks or forced-air cooling. Thermal impedance figures for each device are listed in their respective specification tables.

These devices do not normally require heat sinks, however, standard precautionary design and layout procedures should be used to ensure devices do not

overheat. The ground and power planes beneath the package, as well as all pcb signal runs to and from the device, should be as heavy as possible to help conduct heat away from the package.

Electrically-insulating, thermally-conductive "pads" may be installed underneath the package. Devices should be soldered to boards rather than "socketed," and of course, minimal air flow over the surface can greatly help reduce the package temperature.



Notes: 1.  $f_s = 500\text{kHz}$ .

- The ADS-916 is an edge-triggered device. All internal operations are triggered by the rising edge of the start convert pulse, which may be as narrow as 50nsec. All production testing is performed at a 500kHz sampling rate with 200nsec wide start pulses. For lower sampling rates, wider start pulses may be used, however, a minimum pulse width low of 50nsec must be maintained.

Figure 4. DAC-HF Timing Diagram

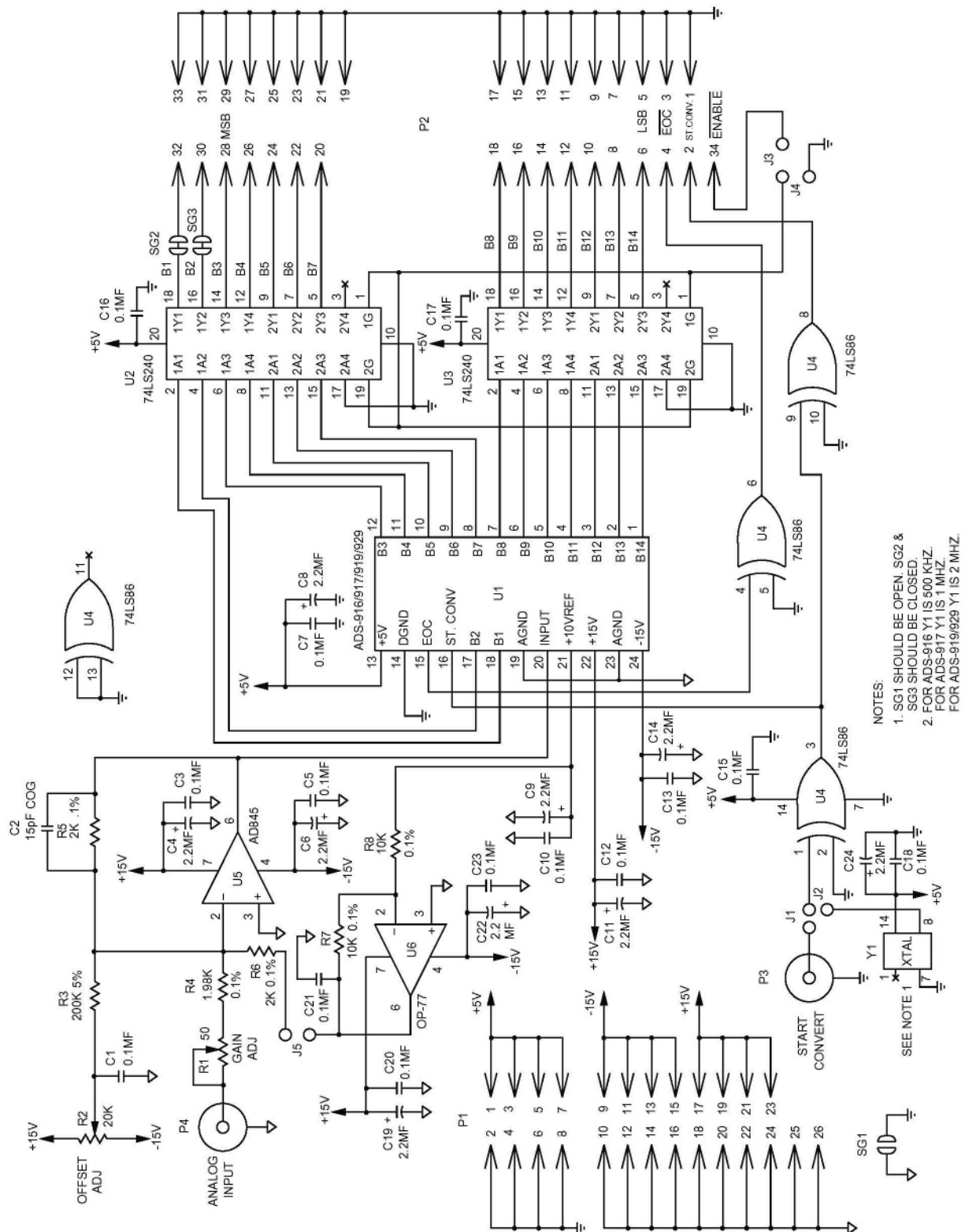


Figure 5. DAC-HF Evaluation Board Schematic

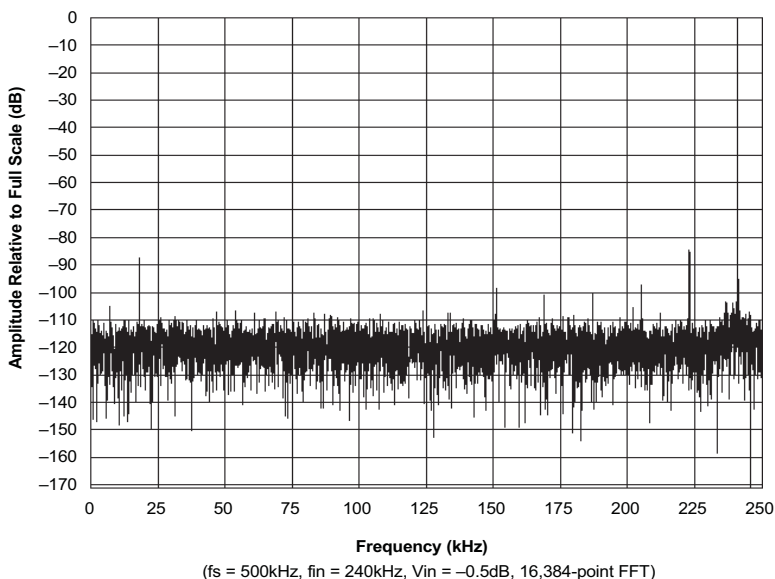


Figure 6. DAC-HF FFT Analysis

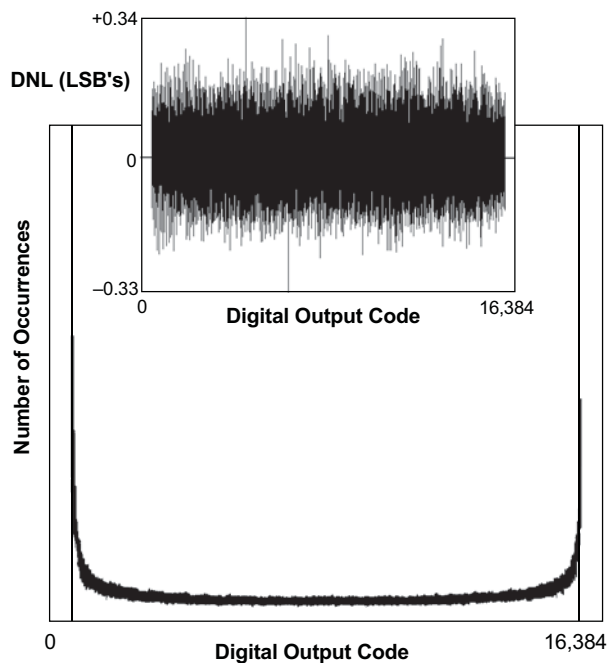
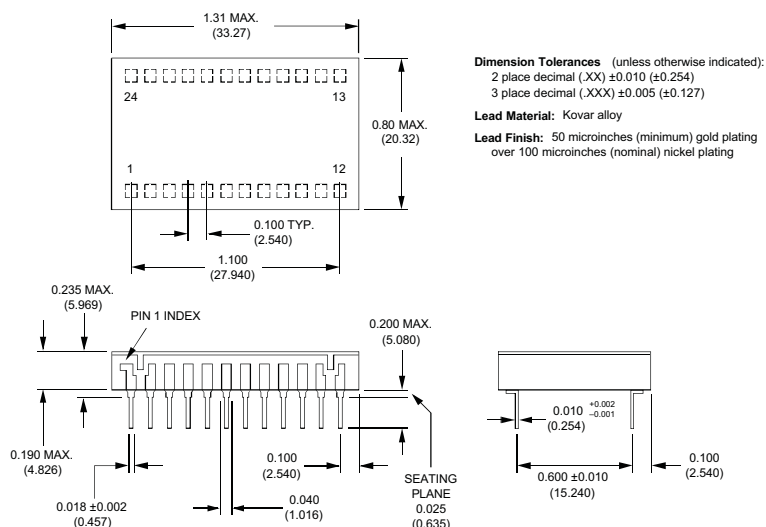


Figure 7. DAC-HF Histogram and Differential Nonlinearity

MECHANICAL DIMENSIONS INCHES (mm)

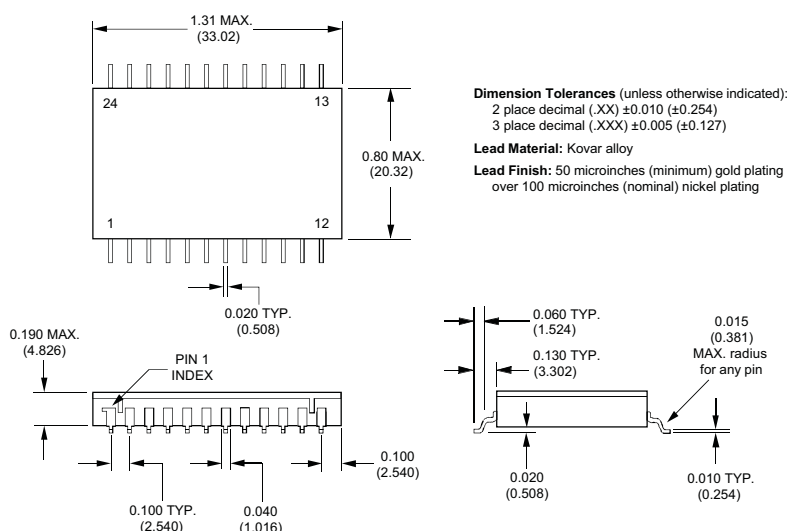
**24-Pin DDIP Versions**

**ADS-916MC**  
**ADS-916MM**  
**ADS-926MC**  
**ADS-926MM**  
**ADS-926/883**



**24-Pin Surface Mount Versions**

**ADS-916GC**  
**ADS-916GM**  
**ADS-926GC**  
**ADS-926GM**



ORDERING INFORMATION

MODEL NUMBER	OPERATING TEMP. RANGE	ANALOG INPUT	ACCESSORIES	
DAC-HFMC	0 to +70°C	Unipolar (0 to +10V)	ADS-B916/917	Evaluation Board (without DAC-HF)
DAC-HFMM	-55 to +125°C	Unipolar (0 to +10V)	HS-24	Heat Sinks for all DAC-HF/926 DDIP models
DAC-HFGC	0 to +70°C	Unipolar (0 to +10V)	Receptacles for PC board mounting can be ordered through AMP Inc. Part #3-331272-8 (Component Lead Socket), 24 required. For MIL-STD-883 product specifications, contact DATEL. * For information, see ADS-926 data sheet.	
DAC-HFGM	-55 to +125°C	Unipolar (0 to +10V)		
ADS-926MC	0 to +70°C	Bipolar ( $\pm 5V$ )*		
ADS-926MM	-55 to +125°C	Bipolar ( $\pm 5V$ )*		
ADS-926GC	0 to +70°C	Bipolar ( $\pm 5V$ )*		
ADS-926GM	-55 to +125°C	Bipolar ( $\pm 5V$ )*		
ADS-926/883	-55 to +125°C	Bipolar ( $\pm 5V$ )*		

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